#### STW22N95K5



# Automotive-grade N-channel 950 V, 0.280 Ω typ., 17.5 A Zener-protected SuperMESH™ 5 Power MOSFET

Datasheet - production data

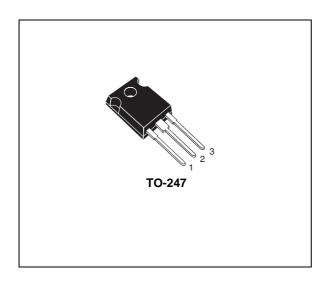
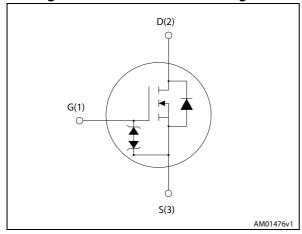


Figure 1. Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>	P <sub>TOT</sub>
STW22N95K5	950 V	0.330 Ω	17.5 A	250 W

- Designed for automotive applications and AEC-Q101 qualified
- Worldwide best FOM (figure of merit)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

#### **Applications**

Switching applications

#### **Description**

This device is an N-channel Power MOSFET developed using SuperMESH™ 5 technology. This revolutionary, avalanche-rugged, high voltage Power MOSFET technology is based on an innovative proprietary vertical structure. The result is a drastic reduction in on-resistance and ultra low gate charge for applications which require superior power density and high efficiency.

**Table 1. Device summary** 

	Order code	Marking	Packages	Packaging
Ī	STW22N95K5	22N95K5	TO-247	Tube

Contents STW22N95K5

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STW22N95K5 Electrical ratings

## 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate- source voltage	± 30	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	17.5	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	11	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	70	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	250	W
I <sub>AR</sub>	Max current during repetitive or single pulse avalanche (pulse width limited by $T_{jmax}$ )	6	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AS}$ , $V_{DD} = 50$ V)	182	mJ
ESD	Gate-source human body model (R= 1,5 k $\Omega$ , C = 100 pF)	2 k	
dv/dt (2)	Peak diode recovery voltage slope	4.5	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T <sub>j</sub>	Operating junction temperature		°C
T <sub>stg</sub>	Storage temperature	-55 to 150	°C

<sup>1.</sup> Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.5	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-amb max	50	°C/W

<sup>2.</sup>  $I_{SD} \leq$  17.5 A, di/dt  $\leq$  100 A/ $\mu$ s,  $V_{DS(peak)} \leq V_{(BR)DSS}$ 

<sup>3.</sup>  $V_{SD} \le 760 \text{ V}$ 

Electrical characteristics STW22N95K5

#### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	950			V
1	Zero gate voltage drain	V <sub>DS</sub> = 950 V,			1	$\mu$ A
I <sub>DSS</sub>	current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 950 V, Tc=125 °C			50	μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A		0.280	0.330	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1550	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> =100 V, f=1 MHz, V <sub>GS</sub> =0	ı	140	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	20 7 20	-	1	1	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	V 0 V 0 to 700 V	-	178	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0$ , $V_{DS} = 0$ to 760 V	ı	65	ı	pF
$R_{G}$	Intrinsic gate resistance	f = 1MHz open drain	-	3.5	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 760 V, I <sub>D</sub> = 17.5 A	-	48	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> =10 V	-	9	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 16)	-	32.5	-	nC

<sup>1.</sup> Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 



<sup>2.</sup> energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	18	-	ns
t <sub>r</sub>	Rise time	$V_{DD} = 475 \text{ V, } I_{D} = 9 \text{ A,} $ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	9	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 18)	-	65	-	ns
t <sub>f</sub>	Fall time		-	18	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		17.5	Α
I <sub>SDM</sub>	Source-drain current (pulsed)		-		70	Α
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 17.5 A, V <sub>GS</sub> =0	-		1.5	٧
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 17.5 A, V <sub>DD</sub> = 60 V	-	513		ns
$Q_{rr}$	Reverse recovery charge	$di/dt = 100 A/\mu s,$	-	12		$\mu$ C
I <sub>RRM</sub>	Reverse recovery current	(see Figure 17)	-	46		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 17.5 A,V <sub>DD</sub> = 60 V	-	670		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt=100 A/µs, Tj=150 °C <i>(see</i>	-	15	·	$\mu$ C
I <sub>RRM</sub>	Reverse recovery current	Figure 17)	-	44		Α

<sup>1.</sup> Pulsed: pulse duration =  $300\mu$ s, duty cycle 1.5%

Table 8. Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)GSO</sub>	Gate-source breakdown voltage	$I_{GS}$ = ± 1 mA, $I_D$ = 0	30	1	1	V

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

Electrical characteristics STW22N95K5

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

10 (A) 10 μs 100μs 1ms 10ms 10ms 10ms

Figure 3. Thermal impedance

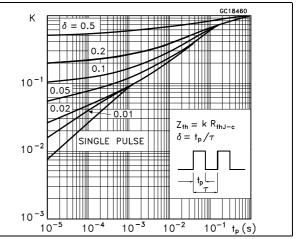


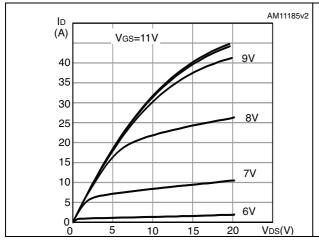
Figure 4. Output characteristics

10

100

VDS(V)

Figure 5. Transfer characteristics



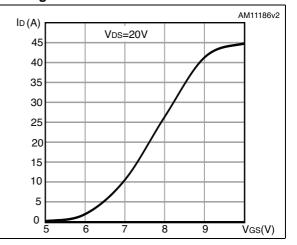
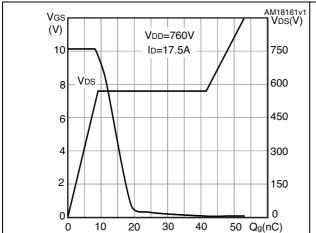
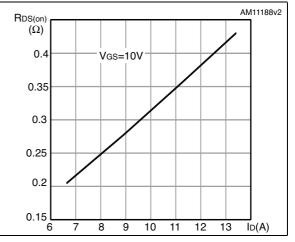


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance





577

C (pF)

10000

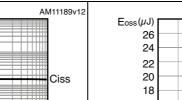
1000

100

10

0.1 0.1

Figure 8. Capacitance variations



Coss

Crss

V<sub>DS</sub>(V)

100

Figure 9. Output capacitance stored energy

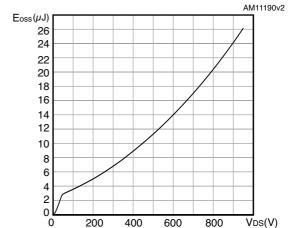
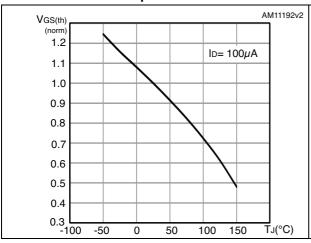


Figure 10. Normalized gate threshold voltage vs temperature

10

Figure 11. Normalized on-resistance vs temperature



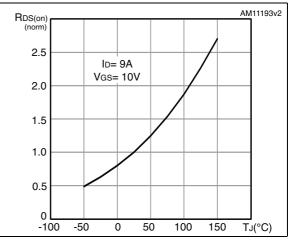
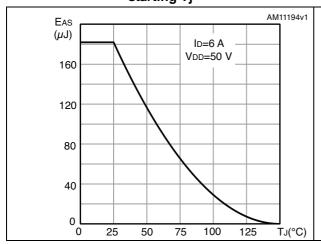
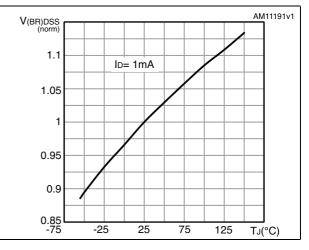


Figure 12. Maximum avalanche energy vs starting Tj

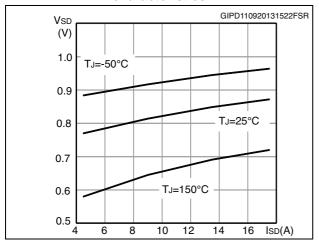
Figure 13. Normalized  $V_{(BR)DSS}$  vs temperature





Electrical characteristics STW22N95K5

Figure 14. Source-drain diode forward characteristics



STW22N95K5 Test circuits

#### 3 Test circuits

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

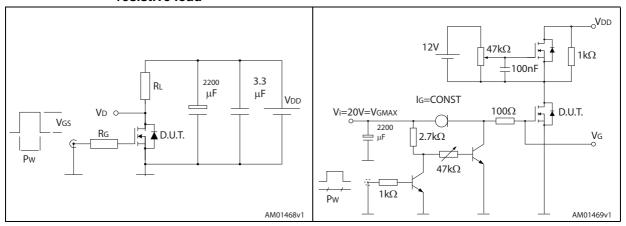


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped inductive load test circuit

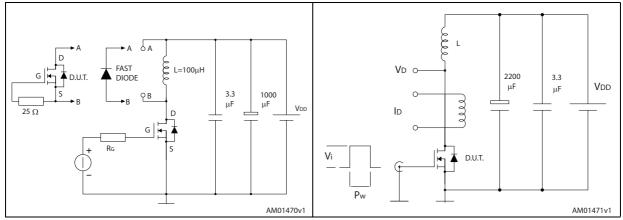
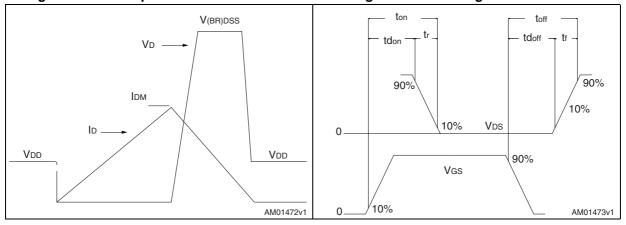


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



HEAT-SINK PLANE

BACK VIEW 0075325, G

Figure 21. TO-247 drawing

Table 9. TO-247 mechanical data

Dim.		mm.	
Dilli.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

STW22N95K5 Revision history

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
17-Oct-2013	1	Initial release.
19-Dec-2013	2	<ul> <li>Datasheet promoted from preliminary data to production data</li> <li>Modified: title and <i>Features</i></li> <li>Minor text changes</li> </ul>
20-Mar-2014	3	<ul> <li>Modified: note 3 in Table 2</li> <li>Modified: Q<sub>gs</sub> and Q<sub>gd</sub> typical values in Table 5</li> <li>Modified: typical values in Table 6 and 7</li> <li>Updated: Figure 6</li> <li>Minor text changes</li> </ul>

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